TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

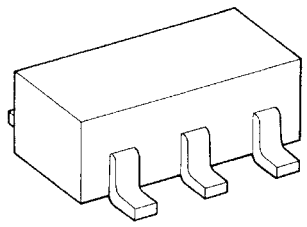
TC7SA05F,TC7SA05FU

Inverter (open drain) with 3.6 V Tolerant Input and Output

Features

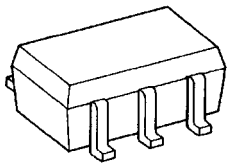
- Low voltage operation : V_{CC} = 1.8~3.6 V
- High speed operation : t_{pd} = 2.8 ns (max) (V_{CC} = 3.0~3.6 V)
  : t_{pd} = 3.7 ns (max) (V_{CC} = 2.3~2.7 V)
  : t_{pd} = 7.4 ns (max) (V_{CC} = 1.8 V)
- High Output current : I_{OH}/I_{OL} = ±24 mA (min) (V_{CC} = 3.0 V)
  : I_{OH}/I_{OL} = ±18 mA (min) (V_{CC} = 2.3 V)
  : I_{OH}/I_{OL} = ±6 mA (min) (V_{CC} = 1.8 V)
- Latch-up performance : ±300 mA or more
- ESD performance : Human body model > ±200 V
  : Machine model > ±2000 V
- Power down protection is provided on all inputs and outputs.

TC7SA05F



SSOP5-P-0.95

TC7SA05FU



SSOP5-P-0.65A

Weight
SSOP5-P-0.95 : 0.016 g (typ.)
SSOP5-P-0.65A : 0.006 g (typ.)

Maximum Ratings (Ta = 25°C)

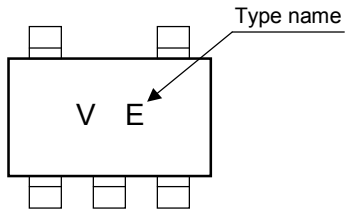
Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	−0.5~4.6	V
DC input voltage	V_{IN}	−0.5~4.6	V
DC output voltage	V_{OUT}	−0.5~4.6 (Note 1)	V
		−0.5~V_{CC} + 0.5 (Note 2)	
Input diode current	I_{IK}	−50	mA
Output diode current	I_{OK}	±50 (Note 3)	mA
DC output current	I_{OUT}	±50	mA
Power dissipation	P_D	200	mW
DC V_{CC}/ground current	I_{CC}	±100	mA
Storage temperature range	T_{stg}	−65~150	°C

Note 1: V_{CC} = 0 V

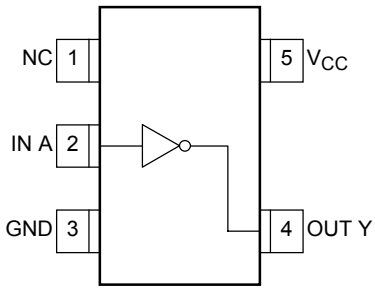
Note 2: High or low state. I_{OUT} absolute maximum rating be observed.

Note 3: V_{OUT} < GND, V_{OUT} > V_{CC}

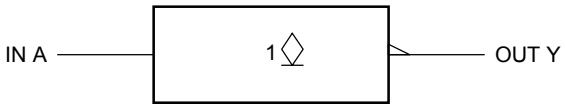
Marking



Pin Assignment (top view)



Logic Diagram



Truth Table

A	Y
L	*H
H	L

*: High impedance

Recommended Operating Range

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	1.8~3.6	V
		1.2~3.6 (Note 4)	
Input voltage	V_{IN}	−0.3~3.6	V
Output voltage	V_{OUT}	0~3.6 (Note 5)	V
		0~V_{CC} (Note 6)	
Output current	I_{OH}/I_{OL}	24 (Note 7)	mA
		18 (Note 8)	
		6 (Note 9)	
Operating temperature range	T_{opr}	−40~85	°C
Input rise and fall time	dt/dv	0~10 (Note 10)	ns/V

Note 4: Data retention only

Note 5: V_{CC} = 0 V

Note 6: High or low state

Note 7: V_{CC} = 3.0~3.6 V

Note 8: V_{CC} = 2.3~2.7 V

Note 9: V_{CC} = 1.8 V

Note 10: V_{IN} = 0.8~2.0 V, V_{CC} = 3.0 V

Electrical Characteristics

DC Characteristics (Ta = –40~85°C, 2.7 V < V_{CC} ≦ 3.6 V)

Characteristics		Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
Input voltage	High level	V_{IH}	—		2.7~3.6	2.0	—	V
	Low level	V_{IL}	—		2.7~3.6	—	0.8	
Output voltage	Low level	V_{OL}	V_{IN} = V_{IH}	I_{OL} = 100 μA	2.7~3.6	—	0.2	V
				I_{OL} = 12 mA	2.7	—	0.4	
				I_{OL} = 18 mA	3.0	—	0.4	
				I_{OL} = 24 mA	3.0	—	0.55	
Input leakage current		I_{IN}	V_{IN} = 0~3.6 V		2.7~3.6	—	±5.0	μA
Power off leakage current		I_{OFF}	V_{IN}, V_{OUT} = 0~3.6 V		0	—	10.0	μA
Quiescent supply current		I_{CC}	V_{IN} = V_{CC} or GND		2.7~3.6	—	20.0	μA
			V_{CC} ≦ (V_{IN}, V_{OUT}) ≦ 3.6 V		2.7~3.6	—	±20.0	
Increase in I_{CC} per input		ΔI_{CC}	V_{IH} = V_{CC} – 0.6 V		2.7~3.6	—	750	

DC Characteristics (Ta = –40~85°C, 2.3 V ≦ V_{CC} ≦ 2.7 V)

Characteristics		Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
Input voltage	High level	V_{IH}	—		2.3~2.7	1.6	—	V
	Low level	V_{IL}	—		2.3~2.7	—	0.7	
Output voltage	Low level	V_{OL}	V_{IN} = V_{IH}	I_{OL} = 100 μA	2.3~2.7	—	0.2	V
				I_{OL} = 12 mA	2.3	—	0.4	
				I_{OL} = 18 mA	2.3	—	0.6	
Input leakage current		I_{IN}	V_{IN} = 0~3.6 V		2.3~2.7	—	±5.0	μA
Power off leakage current		I_{OFF}	V_{IN}, V_{OUT} = 0~3.6 V		0	—	10.0	μA
Quiescent supply current		I_{CC}	V_{IN} = V_{CC} or GND		2.3~2.7	—	20.0	μA
			V_{CC} ≦ (V_{IN}, V_{OUT}) ≦ 3.6 V		2.3~2.7	—	±20.0	

DC Characteristics (Ta = –40~85°C, 1.8 V ≦ V_{CC} < 2.3 V)

Characteristics		Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
Input voltage	High level	V_{IH}	—		1.8~2.3	0.7 × V_{CC}	—	V
	Low level	V_{IL}	—		1.8~2.3	—	0.2 × V_{CC}	
Output voltage	Low level	V_{OL}	V_{IN} = V_{IH}	I_{OL} = 100 μA	1.8	—	0.2	V
				I_{OL} = 6 mA	1.8	—	0.3	
Input leakage current		I_{IN}	V_{IN} = 0~3.6 V		1.8	—	±5.0	μA
Power off leakage current		I_{OFF}	V_{IN}, V_{OUT} = 0~3.6 V		0	—	10.0	μA
Quiescent supply current		I_{CC}	V_{IN} = V_{CC} or GND		1.8	—	20.0	μA
			V_{CC} ≦ (V_{IN}, V_{OUT}) ≦ 3.6 V		1.8	—	±20.0	

AC Characteristics (Ta = –40~85°C, input: t_r = t_f = 2.0 ns, C_L = 30 pF, R_L = 500 Ω)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Max	Unit
Propagation delay time	t_{pZL}	Figure 1, Figure 2	1.8	1.0	8.2	ns
			2.5 ± 0.2	0.8	4.1	
			3.3 ± 0.3	0.6	3.5	
	t_{pLZ}	Figure 1, Figure 2	1.8	1.0	6.8	ns
			2.5 ± 0.2	0.8	3.8	
			3.3 ± 0.3	0.6	3.5	

For C_L = 50 pF, add approximately 300 ps to the AC maximum specification.

Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Typ.	Unit
Quiet output maximum dynamic V_{OL}	V_{OLP}	V_{IN} = 1.8 V, V_{IL} = 0 V (Note 11)	1.8	0.25	ns
		V_{IN} = 2.5 V, V_{IL} = 0 V (Note 11)	2.5	0.6	
		V_{IN} = 3.3 V, V_{IL} = 0 V (Note 11)	3.3	0.8	
Quiet output minimum dynamic V_{OL}	V_{OLV}	V_{IN} = 1.8 V, V_{IL} = 0 V (Note 11)	1.8	−0.25	ns
		V_{IN} = 2.5 V, V_{IL} = 0 V (Note 11)	2.5	−0.6	
		V_{IN} = 3.3 V, V_{IL} = 0 V (Note 11)	3.3	−0.8	
Quiet output minimum dynamic V_{OH}	V_{OLP}	V_{IN} = 1.8 V, V_{IL} = 0 V (Note 11)	1.8	1.5	ns
		V_{IN} = 2.5 V, V_{IL} = 0 V (Note 11)	2.5	1.9	
		V_{IN} = 3.3 V, V_{IL} = 0 V (Note 11)	3.3	2.2	

Note 11: Parameter guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Typ.	Unit
Input capacitance	C_{IN}	—	1.8, 2.5, 3.3		pF
Power dissipation capacitance	C_{PD}	f_{IN} = 10 MHz (Note 12)	1.8, 2.5, 3.3		pF

Note 12: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.
Average operating current can be obtained by the equation.
$I_{CC\ (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

AC Test Circuit

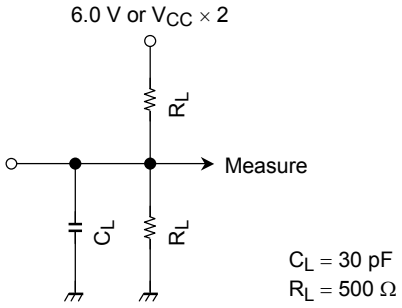
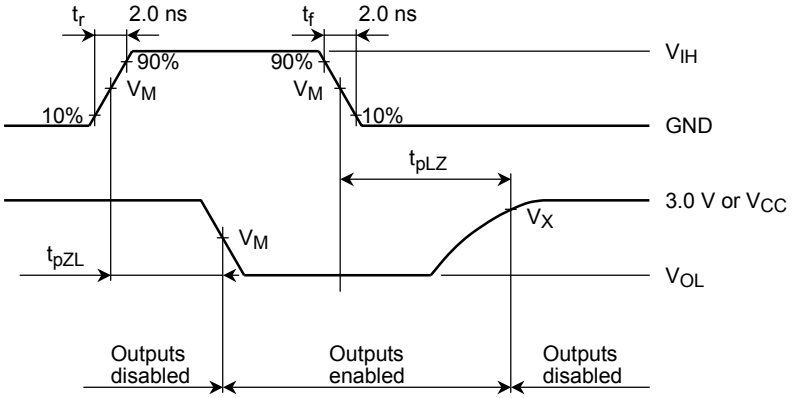


Figure 1

AC Wareform

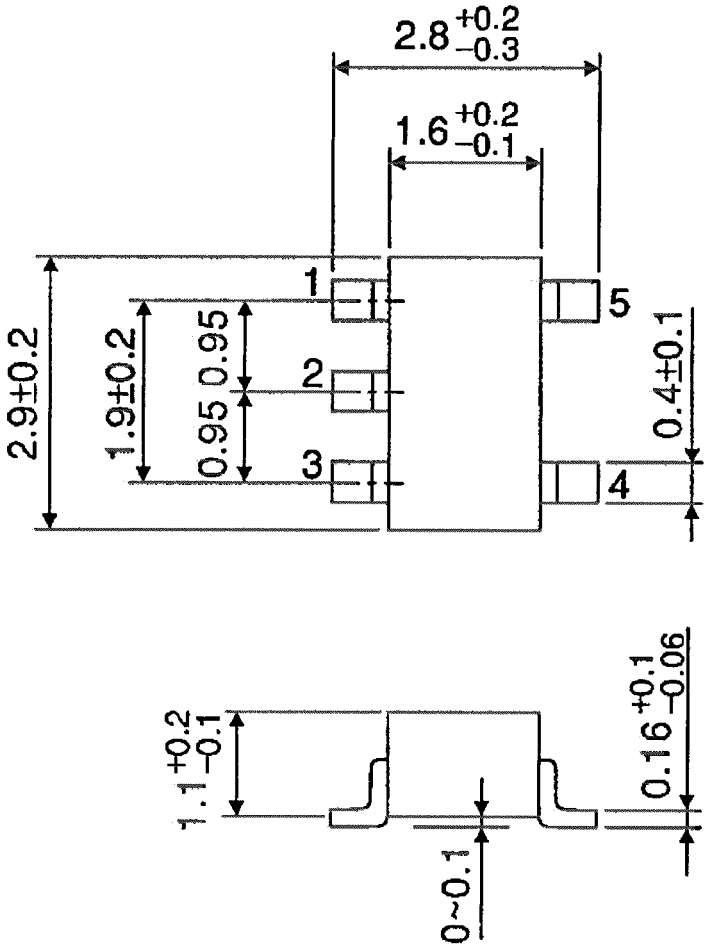


Symbol	V_{CC}		
	3.3 ± 0.3 V	2.5 ± 0.2 V	1.8 V
V_{IH}	2.7 V	V_{CC}	V_{CC}
V_M	1.5 V	$V_{CC}/2$	$V_{CC}/2$
V_X	V_{OH} − 0.3 V	V_{OH} − 0.15 V	V_{OH} − 0.15 V

Figure 2 t_{pZL}, t_{pLZ}

Package Dimensions

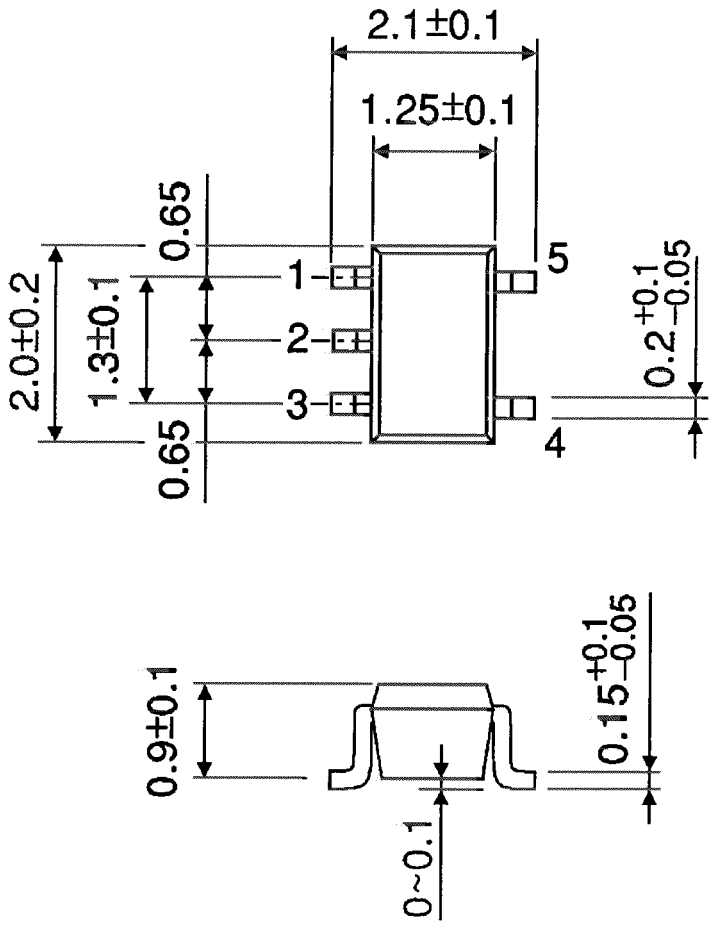
SSOP5-P-0.95 Unit : mm



Weight: 0.016 g (typ.)

Package Dimensions

SSOP5-P-0.65A Unit : mm



Weight: 0.006 g (typ.)

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